



SEMiX® 13

SEMiX101GD12Vs

Features

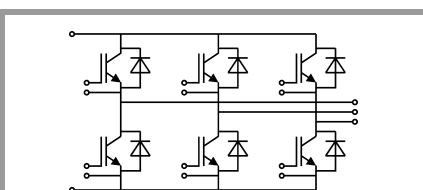
- Homogeneous Si
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability
- UL recognised file no. E63532

Typical Applications*

- AC inverter drives
- UPS
- Electronic Welding

Remarks

- Case temperature limited to $T_C=125^\circ\text{C}$ max.
- Product reliability results are valid for $T_j=150^\circ\text{C}$



GD

Absolute Maximum Ratings				
Symbol	Conditions		Values	Unit
IGBT				
V _{CES}			1200	V
I _C	T _j = 175 °C	T _c = 25 °C	159	A
		T _c = 80 °C	121	A
I _{Cnom}			100	A
I _{CRM}	I _{CRM} = 3xI _{Cnom}		300	A
V _{GES}			-20 ... 20	V
t _{psc}	V _{CC} = 600 V V _{GE} ≤ 15 V V _{CES} ≤ 1200 V	T _j = 125 °C	10	μs
T _j			-40 ... 175	°C
Inverse diode				
I _F	T _j = 175 °C	T _c = 25 °C	121	A
		T _c = 80 °C	91	A
I _{Fnom}			100	A
I _{FRM}	I _{FRM} = 3xI _{Fnom}		300	A
I _{FSM}	t _p = 10 ms, sin 180°, T _j = 25 °C		550	A
T _j			-40 ... 175	°C
Module				
I _{t(RMS)}	T _{terminal} = 80 °C		600	A
T _{stg}			-40 ... 125	°C
V _{isol}	AC sinus 50Hz, t = 1 min		4000	V

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
IGBT						
V _{CE(sat)}	I _C = 100 A	T _j = 25 °C		1.75	2.2	V
	V _{GE} = 15 V chipelevel	T _j = 150 °C		2.2	2.5	V
V _{CE0}		T _j = 25 °C		0.94	1.04	V
		T _j = 150 °C		0.88	0.98	V
r _{CE}	V _{GE} = 15 V	T _j = 25 °C		8.1	11.6	mΩ
		T _j = 150 °C		13.2	15.2	mΩ
V _{GE(th)}	V _{GE} =V _{CE} , I _C = 4 mA		5.5	6	6.5	V
I _{CES}	V _{GE} = 0 V	T _j = 25 °C		0.1	0.3	mA
	V _{CE} = 1200 V	T _j = 150 °C				mA
C _{ies}	V _{CE} = 25 V V _{GE} = 0 V	f = 1 MHz		6.0		nF
C _{oes}		f = 1 MHz		0.59		nF
C _{res}		f = 1 MHz		0.59		nF
Q _G	V _{GE} = - 8 V...+ 15 V			1100		nC
R _{Gint}	T _j = 25 °C			7.50		Ω
t _{d(on)}	V _{CC} = 600 V	T _j = 150 °C		319		ns
t _r	I _C = 100 A	T _j = 150 °C		46		ns
E _{on}	V _{GE} = ±15 Ω	T _j = 150 °C		12.9		mJ
t _{d(off)}	R _{G on} = 1.5 Ω	T _j = 150 °C		482		ns
t _f	di/dt _{on} = 3000 A/μs	T _j = 150 °C		68		ns
E _{off}	di/dt _{off} = 1100 A/μs du/dt _{off} = 6700 V/μs	T _j = 150 °C		11.4		mJ
R _{th(j-c)}	per IGBT				0.27	K/W



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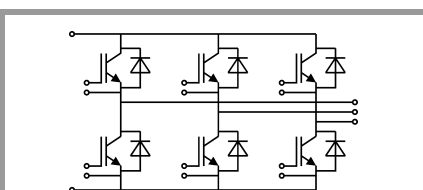
Typical Applications*

- AC inverter drives
- UPS
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Remarks

- Case temperature limited to $T_C=125^\circ\text{C}$ max.
- Product reliability results are valid for $T_J=150^\circ\text{C}$

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Inverse diode						
V _F = V _{EC}	I _F = 100 A V _{GE} = 0 V chip	T _j = 25 °C		2.2	2.52	V
		T _j = 150 °C		2.1	2.5	V
V _{F0}		T _j = 25 °C	1.1	1.3	1.5	V
		T _j = 150 °C	0.7	0.9	1.1	V
r _F		T _j = 25 °C	8.0	9.0	10.2	mΩ
		T _j = 150 °C	10.5	12.5	13.7	mΩ
I _{RRM}	I _F = 100 A	T _j = 150 °C	115			A
Q _{rr}	di/dt _{off} = 2900 A/μs	T _j = 150 °C	18.3			μC
E _{rr}	V _{GE} = -15 V V _{CC} = 600 V	T _j = 150 °C	7.7			mJ
R _{th(j-c)}	per diode		0.48			K/W
Module						
L _{CE}			20			nH
R _{CC'+EE'}	res., terminal-chip	T _C = 25 °C	0.7			mΩ
		T _C = 125 °C	1			mΩ
R _{th(c-s)}	per module		0.04			K/W
M _s	to heat sink (M5)		3	5		Nm
M _t		to terminals (M6)	2.5	5		Nm
				Nm		
w			350			g
Temperatur Sensor						
R ₁₀₀	T _C =100°C (R ₂₅ =5 kΩ)		493 ± 5%			Ω
B _{100/125}	R(T)=R ₁₀₀ exp[B _{100/125} (1/T-1/T ₁₀₀)]; T[K];		3550 ±2%			K



GD

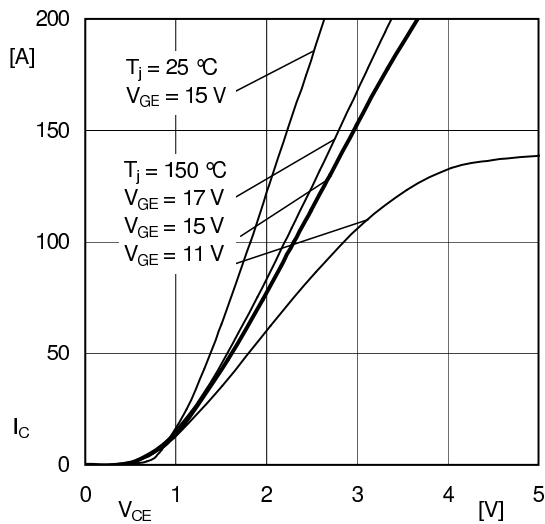


Fig. 1: Typ. output characteristic, inclusive $R_{CC'+EE'}$

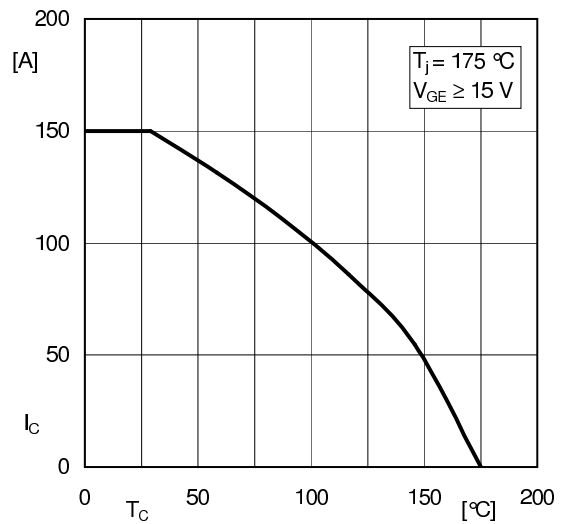


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

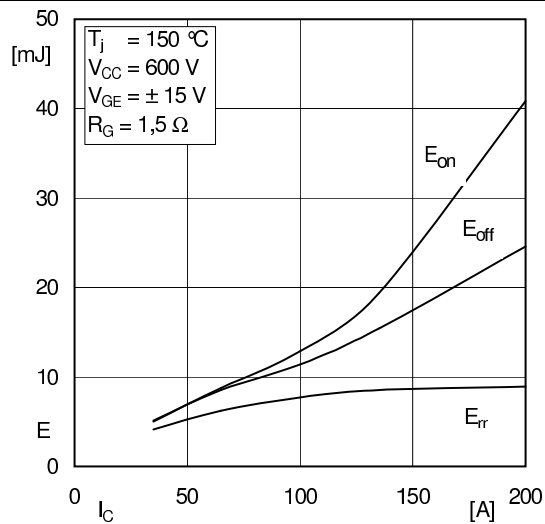


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

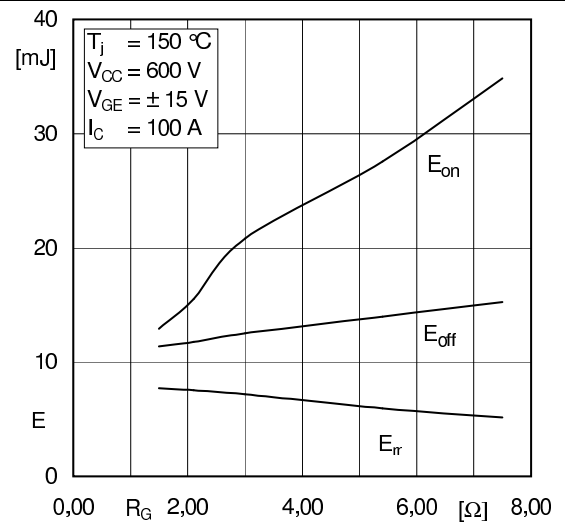


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

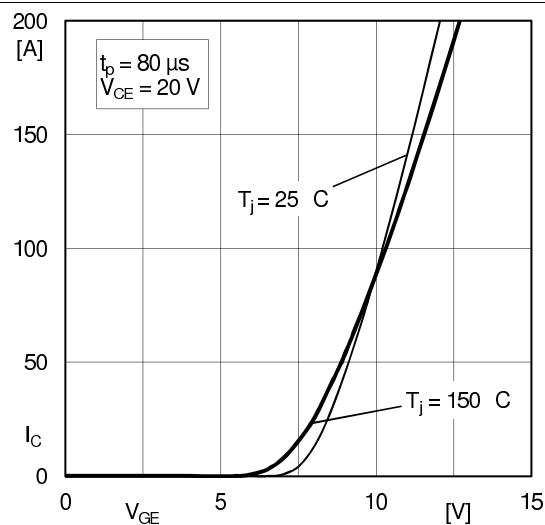


Fig. 5: Typ. transfer characteristic

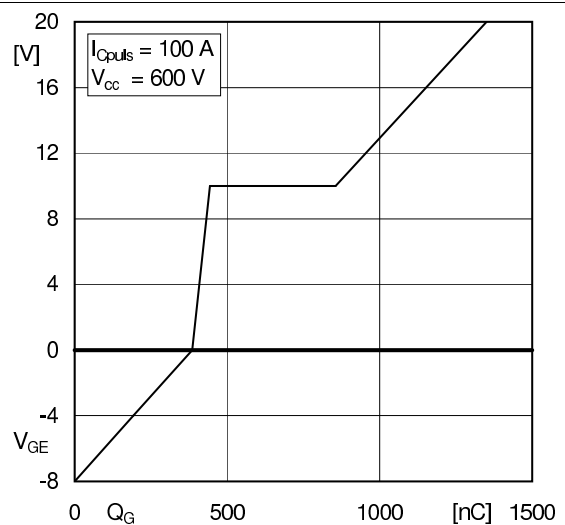


Fig. 6: Typ. gate charge characteristic

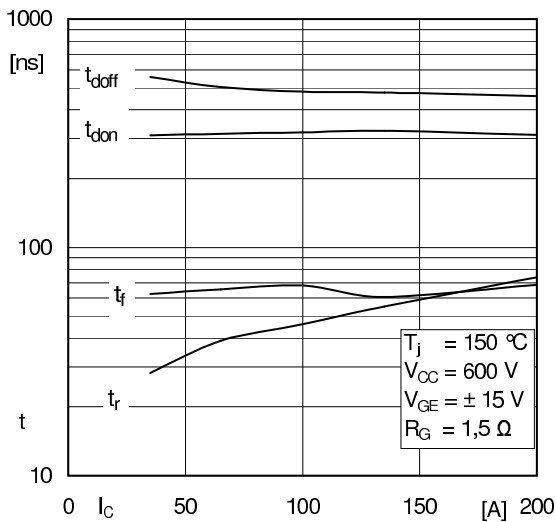


Fig. 7: Typ. switching times vs. I_C

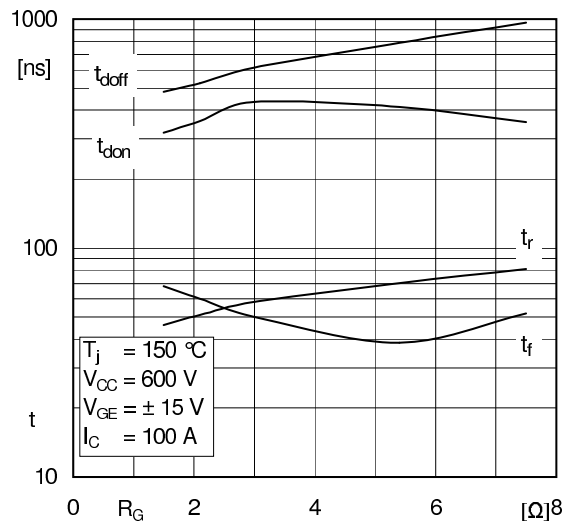


Fig. 8: Typ. switching times vs. gate resistor R_G

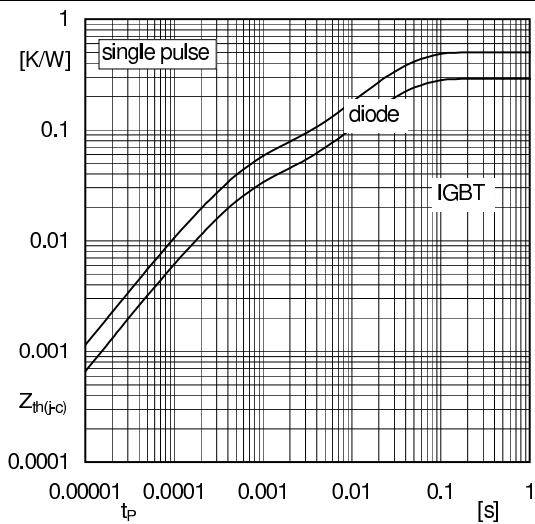


Fig. 9: Typ. transient thermal impedance

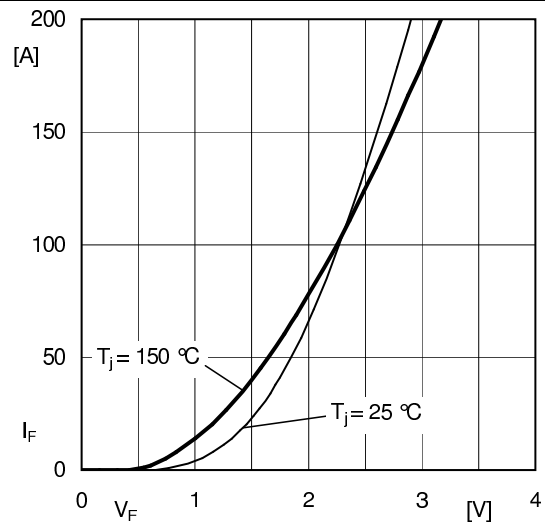


Fig. 10: Typ. CAL diode forward charact., incl. $R_{CC'+EE'}$

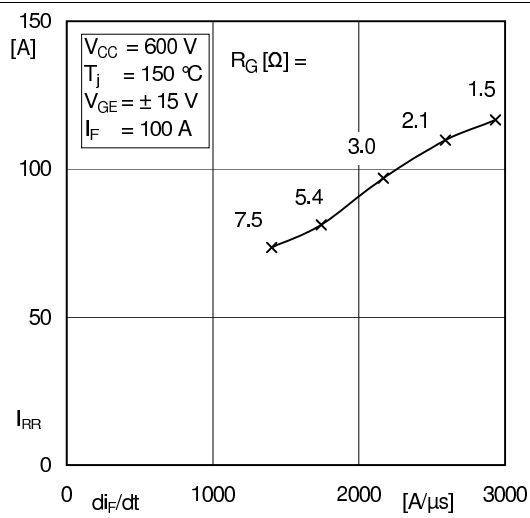


Fig. 11: Typ. CAL diode peak reverse recovery current

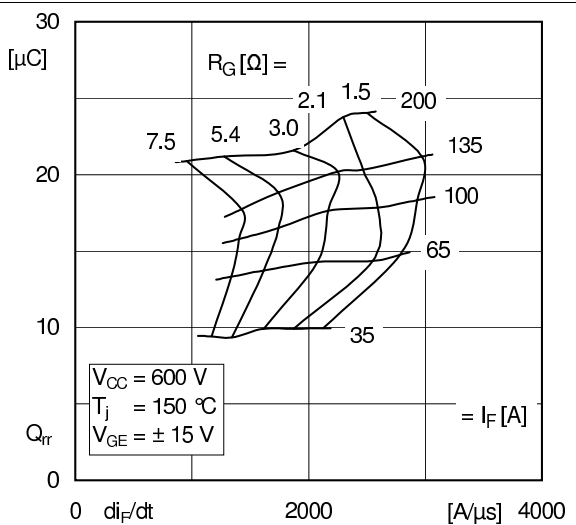


Fig. 12: Typ. CAL diode recovery charge

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